

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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0.8A, 200V - 1000V Glass Passivated Bridge Rectifiers

FEATURES

- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition



MBS





MECHANICAL DATA

Case: Molded plastic body

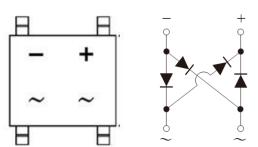
Molding compound, UL flammability classification rating 94V-0

Moisture sensitivity level: level 1, per J-STD-020 Part no. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 2 whisker test **Polarity:** Polarity as marked on the body

Weight: 0.12 g (approximately)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)							
PARAMETER	SYMBOL	MBS2	MBS4	MBS6	MBS8	MBS10	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	200	400	600	800	1000	V
Maximum average forward rectified current On glass-epoxy P.C.B. On aluminum substrate	I _{F(AV)}	0.5 0.8				А	
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	35				Α	
Maximum instantaneous forward voltage (Note 1) I _F = 0.4 A	V _F			1.0			V
	I _R	5 100			μA		
Rating for fusing (t<8.3ms)	l ² t	5.08				A ² s	
Typical junction capacitance per leg (Note 2)	CJ	13				pF	
(Note 3) Typical thermal resistance (Note 4) (Note 3)	$egin{array}{c} R_{ heta JA} \ R_{ heta JA} \end{array}$	20 70 85			°C/W		
Operating junction temperature range	T _J	- 55 to +150				°C	
Storage temperature range	T _{STG}	- 55 to +150			°C		

Note 1: Pulse Test with PW=300µs,1% Duty Cycle

Note 2: Measure at 1.0MHz and Applied Reverse Voltage of 4.0 Volts D.C.

Note 3: On glass epoxy P.C.B. mounted on 0.05" x 0.05" (1.3mm x 1.3mm) pads

Note 4: On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20mm x 20mm) mounted on 0.05" x 0.05" (1.3mm x 1.3mm) solder pads



ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
MBSx (Note 1, 2)	Н	RC	G	MBS	3,000 / 13" Paper reel

Note 1: "x" defines voltage from 200V (MBS2) to 1000V (MBS10)

Note 2: Whole series with green compound

EXAMPLE					
PREFERRED PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
MBS10HRCG	MBS10	Н	RC	G	AEC-Q101 qualified Green compound

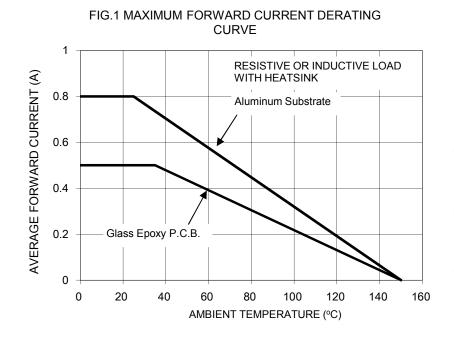
0.01

0

20

RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)



PER LEG 100 INSTANTANEOUS REVERSE CURRENT (µA) 10 T_J=125°C 1 0.1 T_J=25°C

40

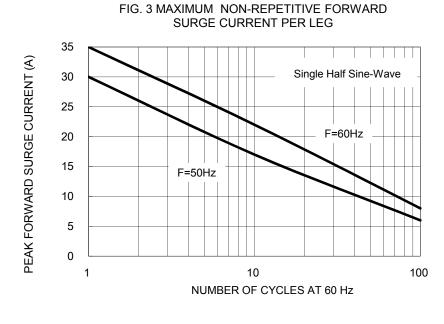
60

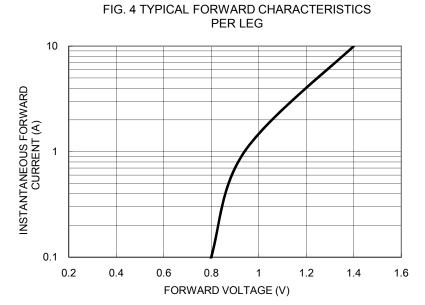
PERCENT OF RATED PEAK REVERSE VOLYAGE(%)

80

100

FIG. 2 TYPICAL REVERSE CHARACTERISTICS





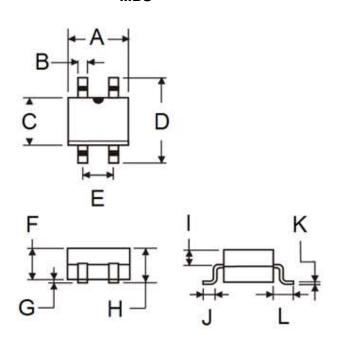
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FIG. 5 TYPICAL JUNCTION CAPACITANCE PER LEG

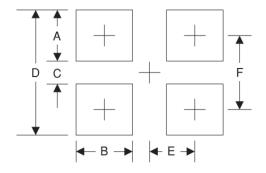
30
25
15
10
5 | f=1.0MHz | Vslg=50mVp-p | 0
0.1 | 1 | 10 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100 | 100

PACKAGE OUTLINE DIMENSIONS MBS



DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min	Min Max		Max	
Α	4.50	4.90	0.177	0.193	
В	0.56	0.84	0.022	0.033	
С	3.60	5.00	0.142	0.197	
D	-	6.90	-	0.272	
Е	2.20	2.60	0.087	0.102	
F	2.30	2.70	0.091	0.106	
G	-	0.20	-	0.008	
Н	-	2.90	-	0.114	
I	0.95	1.53	0.037	0.060	
J	0.70	1.10	0.028	0.043	
K	0.15	0.35	0.006	0.014	
L	1.10	2.12	0.043	0.083	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.7	0.067
В	0.9	0.035
С	4.4	0.173
D	8.1	0.319
E	1.3	0.051
F	6.3	0.248

MARKING DIAGRAM



P/N = Specific Device Code

YW = Date Code

F = Factory Code





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